

## 新品承认书

### NEW PRODUCT APPROVED

客户名称 (CUSTOMERS) \_\_\_\_\_

客户 P/N (CUSTOMER P/N) \_\_\_\_\_

升谱 P/N (SUNPU P/N) \_\_\_\_\_ NEPS-5625ASR-G \_\_\_\_\_

产品说明 (DESCRIPTION) 0.56 英寸双八 共阳 高亮红色显示

送样日期 (SAMPLE DATE) \_\_\_\_\_

|                               |                                     |                           |                          |                     |                          |                     |                          |
|-------------------------------|-------------------------------------|---------------------------|--------------------------|---------------------|--------------------------|---------------------|--------------------------|
| 产品说明书<br><b>Specification</b> | <input checked="" type="checkbox"/> | 检验报告<br><b>INSPECTION</b> | <input type="checkbox"/> | 样品<br><b>SAMPLE</b> | <input type="checkbox"/> | 其它<br><b>OTHERS</b> | <input type="checkbox"/> |
| 核准 (APPROVED BY)              |                                     | 审核 (CHECKED BY)           |                          | 校对 (PROOFREAD BY)   |                          | 制作 (PREPARED BY)    |                          |
|                               |                                     |                           |                          |                     |                          |                     |                          |

#### 更改履历表

| 版本 Version | 日期 date | 描述 | 编制 Maker |
|------------|---------|----|----------|
|            |         |    |          |
|            |         |    |          |
|            |         |    |          |

#### 客户判定结果 (CUSTOMER VERDICT)

承认(OK)

不承认(NG)

承认签名(APPROVED BY):

承认时间(APPROVED DATE):

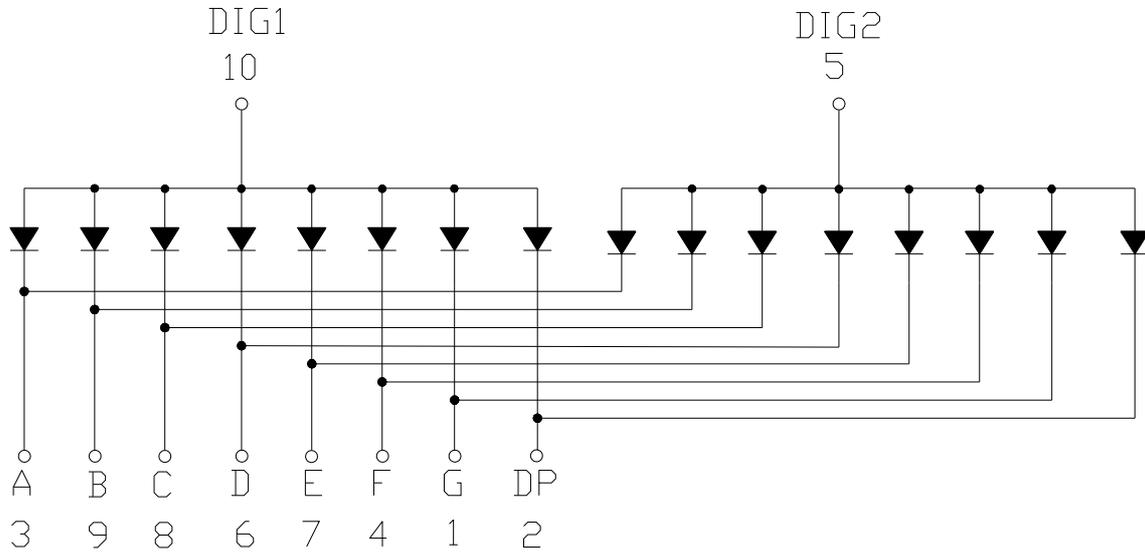
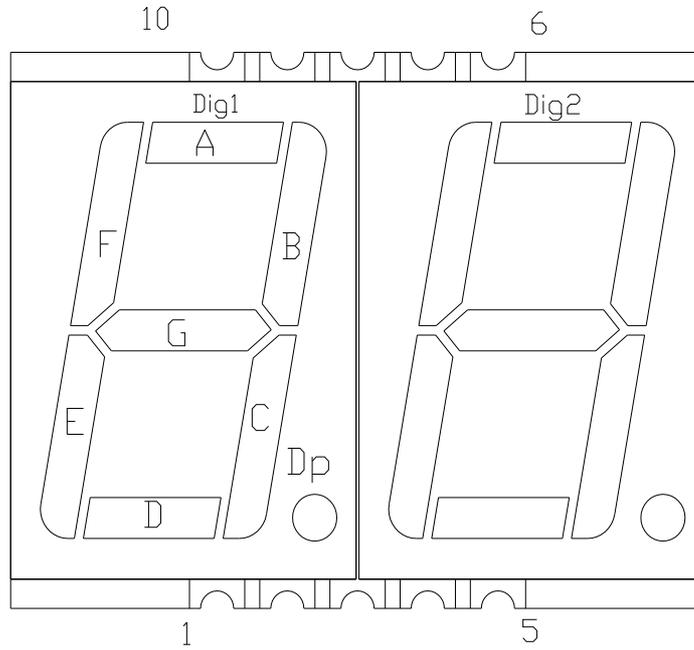
改善意见(IMPROVED ADVICE):

说明: 为了能更好的服务客户, 请及时回传以上信息

**REMARK:** FOR OFFERING THE BEST SERVICE TO CUSTOMER, PLEASE FAX THE DATA TO FACTORY



**4. 产品线路图 INTERNAL CIRCUIT DIAGRAM**

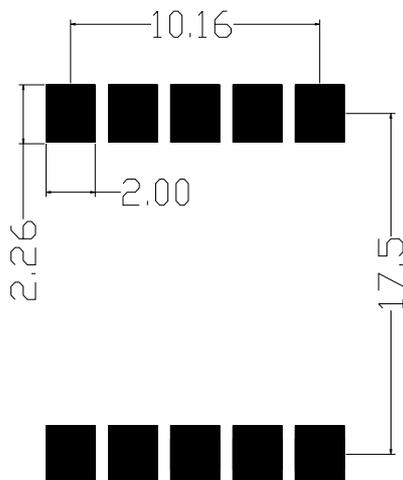


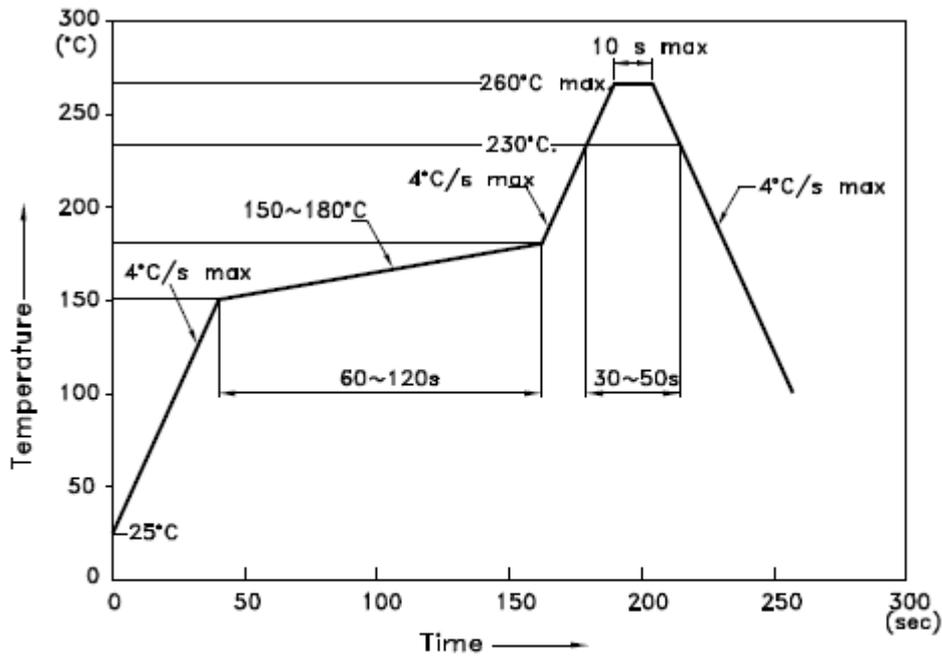
**5、产品最大绝对参数值 (Ta: 25°C) ABSOLUTE MAXIMUM RATINGS AT Ta=25°C:**

| 参数 (PARAMETER)   | 最大值 Max.                | 单位 UNIT      |
|--|-------------------------|--------------|
| 每段功耗 Power Dissipation Per Segment   | <b>52</b>               | <b>mW</b>    |
| 每段峰值电流 Peak Forward Current Per Segment<br>(1/10duty cycle 0.1ms pulse width)                            | <b>100</b>              | <b>mA</b>    |
| 每段平均正向电流 Average Forward Current Per Segment   | <b>20</b>               | <b>mA</b>    |
| 从室温线性减少 Derating Linear From 25°C Per Segment  | <b>0.33</b>             | <b>mA/°C</b> |
| 每段反向电压 Reverse Voltage Per Segment   | <b>5</b>                | <b>V</b>     |
| 工作条件温度 Operating Temperature Range   | <b>-40°C to + 105°C</b> |              |
| 储存温度 Storage Temperature Range   | <b>-40°C to + 105°C</b> |              |
| 距离胶体 1.6mm 焊接, 温度 260°C, 焊接时间最多 3 秒<br>Lead Soldering Temperature 260°C at 1.6mm From Body for 3 seconds |                         |              |

**6、产品光电参数值 (Ta: 25°C) ELECTRICAL/OPTICAL CHARACTERISTICS AT Ta=25°C:**

| 参数<br>PARAMETER                     | 符号<br>SYMBOL    | MIN. | TYP.       | MAX.       | UNIT       | 测试条件<br>Test condition    |
|-------------------------------------|-----------------|------|------------|------------|------------|---------------------------|
| 每段亮度 Luminous Intensity Per Segment | $I_v$           | —    | <b>15</b>  | —          | <b>mcd</b> | <b>I<sub>F</sub>=10mA</b> |
| 主波长 Dominant Wavelength             | $\lambda_d$     | —    | <b>620</b> | —          | <b>nm</b>  | <b>I<sub>F</sub>=20mA</b> |
| 光谱半宽度 Spectral Line Half-Width      | $\Delta\lambda$ | —    | <b>30</b>  | —          | <b>nm</b>  | <b>I<sub>F</sub>=20mA</b> |
| 每颗正向电压 Forward Voltage Per Dice     | $V_F$           | —    | <b>2.0</b> | <b>2.6</b> | <b>V</b>   | <b>I<sub>F</sub>=20mA</b> |
| 每颗反向电流 Reverse Current Per Dice     | $I_R$           | —    | —          | <b>50</b>  | <b>μA</b>  | <b>V<sub>R</sub>=5V</b>   |

**7、推荐使用的焊盘尺寸 Recommended Soldering Pattern:**

**8、推荐的 SMT 焊接曲线 Recommended SMT condition:**



NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.